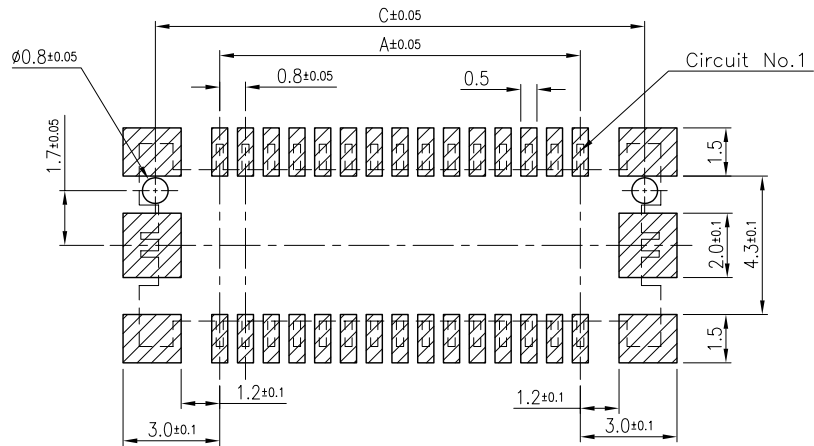
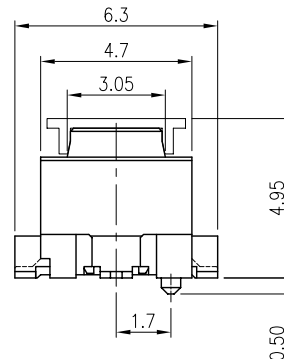
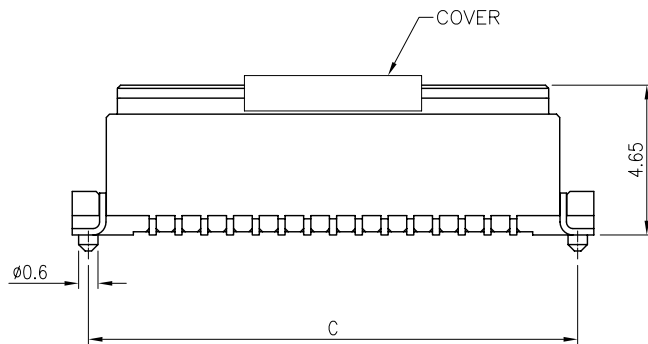
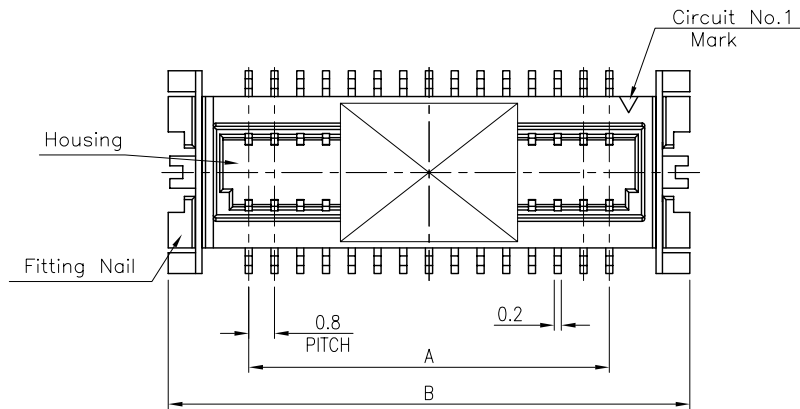




PCB PATTERN LAYOUT



NOTES:

1. MATERIAL:

1.1 HOUSING: THALOGEN FREE PLASTIC, HIGH TEMP., UL94V-0

1.2 CONTACT: COPPER ALLOY

1.3 FITTING NAIL: COPPER ALLOY

2. FINISH:

SEE ACES P/N. PLATING CODE

3. REFLOW SOLDER CAPABLE TO 260°C

PER ACES SPEC.

4. SPEC. PLS. REFER TO PS-50110-XXXXX-XXX

5. PACKAGE PLS. REFER TO 88013-XXXX-TRP

6. PART NUMBER

50119-XXX X X-XXX

NO OF CKT

XXX	MATERIAL	COLOR
001	HF PLASTIC	BLACK

PACKING

0:TAPE REEL

1:TUBE

7:TAPE REEL WITH COVER

8:TUBE WITH COVER

PLATING

N:MATT TIN(LEAD FREE)

1:GOLD FLASH OVER ALL

CKT	Dim A	Dim B	Dim C
10	3.2	8.2	7.2
12	4.0	9.0	8.0
14	4.8	9.8	8.8
16	5.6	10.6	9.6
20	7.2	12.2	11.2
24	8.8	13.8	12.8
30	11.2	16.2	15.2
34	12.8	17.8	16.8
36	13.6	18.6	17.6
40	15.2	20.2	19.2
50	19.2	24.2	23.2
60	23.2	28.2	27.2
80	31.2	36.2	35.2

一般公差 TOLERANCES X ±0.5 XX ±0.15 X ±0.25 XXX ±0.1 ANGLES ±2°		宏致電子股份有限公司 Aces Electronic Co.,Ltd.	
檢驗尺寸標示 SYMBOLS ① ② INDICATE CLASSIFICATION DIMENSION ① MARK IS CRITICAL DIM. ② MARK IS MAJOR DIM.	品名 (TITLE) - 0.8mm BTB D/R - CONN. SMT S/T TYPE 圖號 (DWG.NO) 50119-XXXXX-XXX	製圖 (DR) '08/10/07 審核 (CHKD) WGCH 核准 (APPD) Jason.C	張數 (SHEET) 1 OF 1 SIZE A4 REV 0
表面處理 (FINISH)	比例 (SCALE) 5:1	單位 (UNITS) mm	① ②

0	新圖製成	'08/10/07	Keen
REV	修改摘要 REVISION DESCRIPTION	日期 DATE	簽名 SIGNATURE